

Standard Rectifier

 V_{RRM} 1600 V

I_{FAV} 10 A

1.21 V

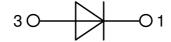
Single Diode

Part number

DMA10I1600PA



Backside: cathode



Features / Advantages:

- Planar passivated chips
- Very low leakage current Very low forward voltage drop
- Improved thermal behaviour

Applications:

- Diode for main rectification
- For single and three phase bridge configurations

Package: TO-220

- Industry standard outline
- RoHS compliant
- Epoxy meets UL 94V-0

Terms and Conditions of Usage

The data contained in this product data sheet is exclusively intended for technically trained staff. The user will have to evaluate the suitability of the product for the intended application and the completeness of the product data with respect to his application. The specifications of our components may not be considered as an assurance of component characteristics. The information in the valid application- and assembly notes must be considered. Should you require product information in excess of the data given in this product data sheet or which concerns the specific application of your product, please contact your local sales office.

Due to technical requirements our product may contain dangerous substances. For information on the types in question please contact your local sales office.

Should you intend to use the product in aviation, in health or life endangering or life support applications, please notify. For any such application we urgently recommend

to perform joint risk and quality assessments;
the conclusion of quality agreements;

- to establish joint measures of an ongoing product survey, and that we may make delivery dependent on the realization of any such measures.

IXYS reserves the right to change limits, conditions and dimensions.

Data according to IEC 60747 and per semiconductor unless otherwise specified

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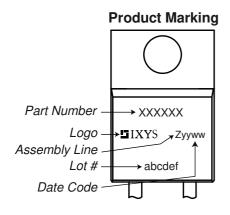




Rectifier					Ratings		
Symbol	Definition	Conditions		min.	typ.	max.	Unit
V _{RSM}	max. non-repetitive reverse blo	cking voltage	$T_{VJ} = 25^{\circ}C$			1700	V
V_{RRM}	max. repetitive reverse blocking	y voltage	$T_{VJ} = 25^{\circ}C$			1600	V
I _R	reverse current	V _R = 1600 V	$T_{VJ} = 25^{\circ}C$			10	μΑ
		$V_R = 1600 V$	$T_{VJ} = 150$ °C			0.2	mΑ
V _F	forward voltage drop	I _F = 10 A	$T_{VJ} = 25^{\circ}C$			1.26	V
		$I_F = 20 A$				1.53	V
		I _F = 10 A	$T_{VJ} = 150$ °C			1.21	V
		$I_F = 20 A$				1.57	V
I FAV	average forward current	T _C = 150°C	T _{vJ} = 175°C			10	Α
		rectangular $d = 0.5$					i ! !
V _{F0}	threshold voltage		T _{vJ} = 175°C			0.82	V
\mathbf{r}_{F}	slope resistance } for power	r loss calculation only				37	mΩ
R _{thJC}	thermal resistance junction to c	ase				1.5	K/W
R _{thCH}	thermal resistance case to heat	sink			0.50		K/W
P _{tot}	total power dissipation		$T_{C} = 25^{\circ}C$			100	W
I _{FSM}	max. forward surge current	t = 10 ms; (50 Hz), sine	$T_{VJ} = 45^{\circ}C$			120	Α
		t = 8,3 ms; (60 Hz), sine	$V_R = 0 V$			130	Α
		t = 10 ms; (50 Hz), sine	T _{VJ} = 150°C			100	Α
		t = 8.3 ms; (60 Hz), sine	$V_R = 0 V$			110	Α
I²t	value for fusing	t = 10 ms; (50 Hz), sine	$T_{VJ} = 45^{\circ}C$			72	A ² s
		t = 8.3 ms; (60 Hz), sine	$V_R = 0 V$			70	A²s
		t = 10 ms; (50 Hz), sine	T _{VJ} = 150°C			50	A ² s
		t = 8,3 ms; (60 Hz), sine	$V_R = 0 V$			50	A²s
C	junction capacitance	$V_R = 400 \text{ V}; f = 1 \text{ MHz}$	$T_{VJ} = 25^{\circ}C$		4		pF



Package TO-220			Ratings			
Symbol	Definition	Conditions	min.	typ.	max.	Unit
I _{RMS}	RMS current	per terminal			25	Α
T _{vJ}	virtual junction temperature		-55		175	°C
T _{op}	operation temperature		-55		150	°C
T _{stg}	storage temperature		-55		150	°C
Weight				2		g
M _D	mounting torque		0.4		0.6	Nm
F _c	mounting force with clip		20		60	N



Part description

D = Diode

M = Standard Rectifier

A = (up to 1800V)

10 = Current Rating [A]

I = Single Diode

1600 = Reverse Voltage [V] PA = TO-220AC (2)

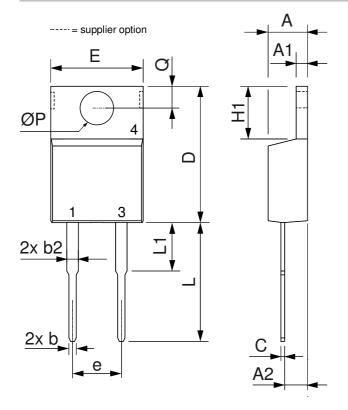
Ordering	Ordering Number	Marking on Product	Delivery Mode	Quantity	Code No.
Standard	DMA10I1600PA	DMA10I1600PA	Tube	50	508780

Similar Part	Package	Voltage class
DMA10IM1600PZ	TO-263AB (D2Pak) (2HV)	1600

Equiva	alent Circuits for	Simulation	* on die level	$T_{VJ} = 175 ^{\circ}\text{C}$
$I \rightarrow V_0$)— <u>R</u> o	Rectifier		
V _{0 max}	threshold voltage	0.82		V
$R_{0\;max}$	slope resistance *	34		$m\Omega$



Outlines TO-220



Dim.	Millimeter		Inches	
	Min.	Max.	Min.	Max.
Α	4.32	4.82	0.170	0.190
A1	1.14	1.39	0.045	0.055
A2	2.29	2.79	0.090	0.110
b	0.64	1.01	0.025	0.040
b2	1.15	1.65	0.045	0.065
С	0.35	0.56	0.014	0.022
D	14.73	16.00	0.580	0.630
E	9.91	10.66	0.390	0.420
е	5.08	BSC	0.200	BSC
H1	5.85	6.85	0.230	0.270
L	12.70	13.97	0.500	0.550
L1	2.79	5.84	0.110	0.230
ØP	3.54	4.08	0.139	0.161
Q	2.54	3.18	0.100	0.125





Rectifier

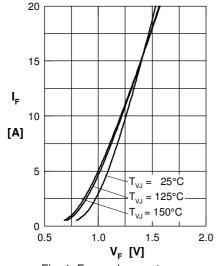


Fig. 1 Forward current versus voltage drop per diode

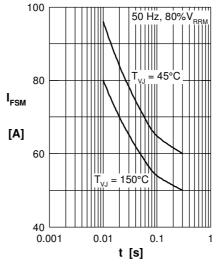


Fig. 2 Surge overload current

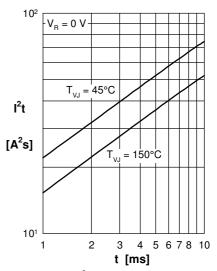


Fig. 3 I²t versus time per diode

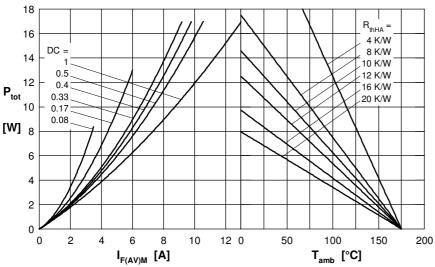


Fig. 4 Power dissipation vs. direct output current and ambient temperature

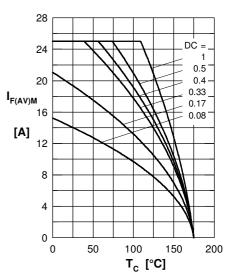


Fig. 5 Max. forward current vs. case temperature

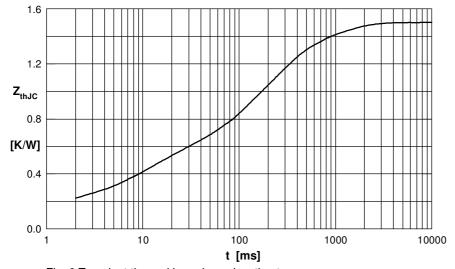


Fig. 6 Transient thermal impedance junction to case

Constants for Z_{thJC} calculation:

i	R_{thi} (K/W)	t _i (s)
1	0.155	0.0005
2	0.332	0.0095
3	0.713	0.17
4	0.3	8.0